



P-Channel 30 V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)	Q _g (Typ.)		
	0.167 at V _{GS} = - 10 V	0.96			
- 30	0.188 at V _{GS} = - 4.5 V	0.90	3.25		
	0.244 at V _{GS} = - 2.5 V	0.79			

FEATURES

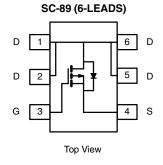
- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET[®] Power MOSFET
- 100 % R_g Tested
- Compliant to RoHS Directive 2002/95/EC

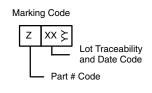


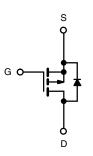
ROHS COMPLIANT HALOGEN FREE

APPLICATIONS

• Load Switch for Portable Devices







Ordering Information: Si1071X-T1-GE3 (Lead (Pb)-free and Halogen-free)

P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	(T _A = 25 °C, unle	ess otherwise no	oted)		
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	- 30	V	
Gate-Source Voltage		V _{GS}	± 12	v	
Continuous Drain Current /T 150 °C\	T _A = 25 °C	1-	- 0.96 ^{b, c}		
Continuous Drain Current (T _J = 150 °C)	T _A = 70 °C	I _D	- 0.76 ^{b, c}		
Pulsed Drain Current		I _{DM}	- 8	A	
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	- 0.2 ^{b, c}		
M ·	T _A = 25 °C	D.	0.236 ^{b, c}	w	
Maximum Power Dissipation ^a	T _A = 70 °C	- P _D —	0.151 ^{b, c}	vv	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Manipulation to Applicate h	t ≤ 5 s	- R _{thJA}	440	530	°C/W	
Maximum Junction-to-Ambient ^{a, b}	Steady State		540	650	C/VV	

Notes:

- a. Maximum under steady state conditions is 650 °C/W.
- b. Surface mounted on 1" x 1" FR4 board.
- c. t = 5 s.

Vishay Siliconix



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static				'		
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V, I}_{D} = -250 \mu\text{A}$	- 30			V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	J 050 A		- 32.07		mV/°C
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	l _D = - 250 μA		3.02		
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = -250 \mu A$	- 0.7		- 1.45	V
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 12 \text{ V}$			± 100	nA
Zero Osto Voltago Desir O	1	V _{DS} = - 30 V, V _{GS} = 0 V			- 1	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = - 30 V, V _{GS} = 0 V, T _J = 85 °C			- 10	μΑ
On-State Drain Current ^a	I _{D(on)}	$V_{DS} = \ge 5 \text{ V}, V_{GS} = -10 \text{ V}$	- 8			Α
Drain-Source On-State Resistance ^a		V _{GS} = - 10 V, I _D = - 0.96 A		0.139	0.167	
	R _{DS(on)}	V _{GS} = - 4.5 V, I _D = - 0.9 A		0.147	0.177	Ω
		V _{GS} = - 2.5 V, I _D = - 0.79 A		0.195	0.244	1
Forward Transconductance	9 _{fs}	V _{DS} = - 15 V, I _D = - 0.96 A		4.25		S
Dynamic ^b				'		
Input Capacitance	C _{iss}			315		
Output Capacitance	C _{oss}	V _{DS} = - 15 V, V _{GS} = 0 V, f = 1 MHz		60		pF
Reverse Transfer Capacitance	C _{rss}			45		
T. 10 . 0	0	$V_{DS} = -15 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -0.96 \text{ A}$		4.43	6.64	nC
Total Gate Charge	Q_g			8.87	13.3	
Gate-Source Charge	Q_{gs}	$V_{DS} = -15 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -0.96 \text{ A}$		0.83		
Gate-Drain Charge	Q_{gd}			1.57		
Gate Resistance	R_g	f = 1 MHz		9.8	14.7	Ω
Turn-On Delay Time	t _{d(on)}			3.8	5.7	
Rise Time	t _r	$V_{DD} = -15 \text{ V}, R_{L} = 19.74 \Omega$		12	18	
Turn-Off DelayTime	t _{d(off)}	$I_D \cong$ - 0.76 A, V_{GEN} = - 10 V, R_g = 1 Ω		18	27	
Fall Time	t _f			7	10.5	
Turn-On Delay Time	t _{d(on)}			13	20	ns
Rise Time	t _r	$V_{DD} = -15 \text{ V}, R_{L} = 20.27 \Omega$		25	38	
Turn-Off DelayTime	t _{d(off)}	$I_D \cong$ - 0.74 A, V_{GEN} = - 4.5 V, R_g = 1 Ω		36	54	
Fall Time	t _f			14	21	
Drain-Source Body Diode Character	istics					
Pulse Diode Forward Current ^a	I _{SM}				8	Α
Body Diode Voltage	V_{SD}	I _S = - 0.63 A		0.8	1.2	V
Body Diode Reverse Recovery Time	t _{rr}			12.7	19.05	nC
Body Diode Reverse Recovery	dy Diode Reverse Recovery Q.,			5.7	8.6	
Reverse Recovery Fall Time	t _a	$I_F = -0.7 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}$		8.9		ns
		† †				1

Notes:

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.





TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)

6

Q_q - Total Gate Charge (nC)

Gate Charge

10

- 50

- 25

0

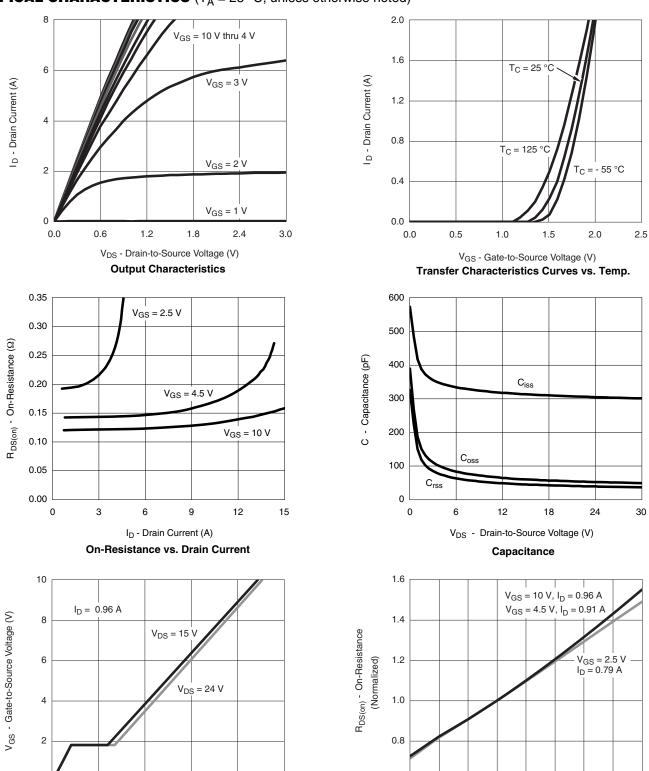
25

50

 T_J - Junction Temperature (°C)

On-Resistance vs. Junction Temperature

75



0

125

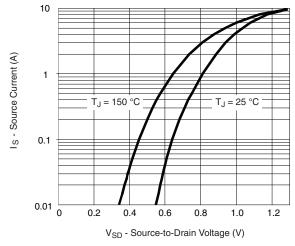
100

150

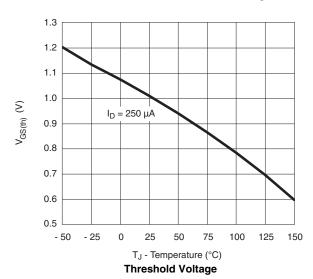
Vishay Siliconix

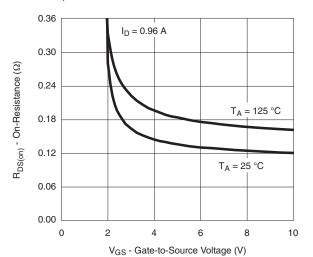
VISHAY

TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)

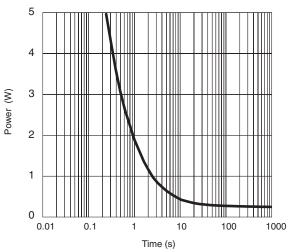


Source-Drain Diode Forward Voltage

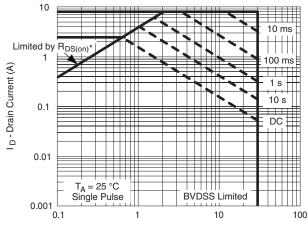




On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power



V_{DS} - Drain-to-Source Voltage (V)

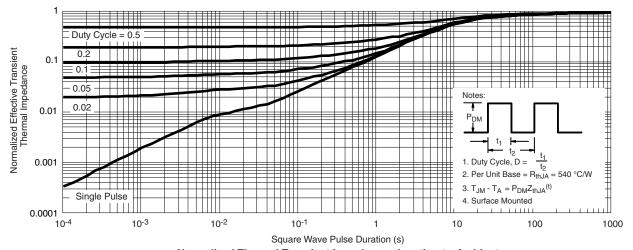
 * V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

Safe Operating Area, Junction-to-Ambient





TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?74321.



Legal Disclaimer Notice

Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

Revision: 13-Jun-16 1 Document Number: 91000